DECLARATION FOR PATENT APPLICATION AND POWER OF ATTORNEY

| (Application Serial Number) (Day/Month/Year Filed) | (Status-Patented, Pending or Abandoned | l) |
|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------|----------------------------------------|
| (Application Serial Number) (Day/Month/Year Filed) | (Status-Patented, Pending or Abandoned | 1) |
| between the filing date of the prior application(s) and the national or PCT | international filing date of this application: | |
| to disclose to the Office all information known to me to be material to pa | | ccurred |
| not disclosed in the prior application(s) in the manner provided by the fir | _ | - |
| designating the United States of America listed below and, insofar as the | | |
| I hereby claim the benefit under 35 U.S.C. §120 of any United S | | |
| , | | |
| (Application Serial Number) | (Day/Month/Year Filed) | |
| (Application Serial Number) | (Day/Month/Year Filed) | |
| I hereby claim the benefit under 35 U.S.C. §119(e) of any United | States provisional application(s) listed below: | |
| (Application Serial Number) (Country) (Day/Month/Year | Filed) Price Yes | No |
| (Application Serial Number) (Country) (Day/Month/Year | , | No |
| 2002-38977 Republic of Korea 05/07/200 | 2 | |
| | Priority | y Claimed |
| having a filing date before that of the application(s) of which priority is of | - | |
| application(s) designating at least one country other than the United Stat | - | |
| listed below and have also identified below any foreign application(s) fo | | |
| certificate or of any PCT international application(s) designating at least | - | |
| I hereby claim foreign priority benefits under 35 U.S.C. §119 o | fany foreign amplication(a) for any foreign | |
| Sears Tower, 233 S. Wacker Drive, Chicago, IL 60606-6357, to insert a application. | bove the filing date and/or Application No. of sa | aid |
| such information is deemed necessary, I hereby authorize and request m | | |
| In the event that the filing date and/or Application No. are not experienced in the second se | | |
| known to me to be material to patentability as defined in 37 C.F.R. §1.50 | | |
| any amendment(s) referred to above. I acknowledge the duty to disclose | | tion |
| state that I have reviewed and understand the contents of the above-iden | | - |
| on and was amended under Article | · · · · · · · · · · · · · · · · · · | • |
| and was amended on (if applicable | e); was filed as PCT International Application | No. |
| the specification of which: 🖰 is attached hereto; 🗆 was filed | on as Application | n Serial No |
| SEMICONDUCTOR DEVICE | | ······································ |
| invention entitled "METHOD FOR FORMING METAL SILICID | E LAYER IN ACTIVE AREA OF | ii die |
| joint inventor (if plural names are listed below) of the subject matter wh | | |
| next to my name; I believe that I am the original, first and sole inventor | • | |
| | | |

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under 18 U.S.C. §1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

POWER OF ATTORNEY: I hereby appoint as my attorneys, with full powers of substitution and revocation, to prosecute this application and transact all business in the Patent and Trademark Office connected therewith:

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